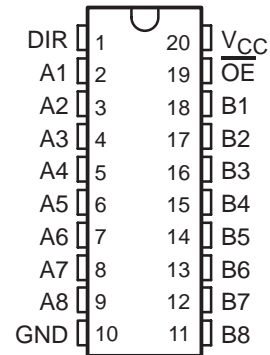


# SN54BCT640, SN74BCT640 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS025C – SEPTEMBER 1988 – REVISED APRIL 1994

- State-of-the-Art BiCMOS Design Substantially Reduces Standby Current
- Outputs Have Undershoot-Protection Circuitry
- Power-Up High-Impedance State
- Buffered Control Inputs to Reduce DC Loading Effects
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK) and Flatpacks (W), and Plastic and Ceramic 300-mil DIPs (J, N)

SN54BCT640 . . . J OR W PACKAGE  
SN74BCT640 . . . DW OR N PACKAGE  
(TOP VIEW)

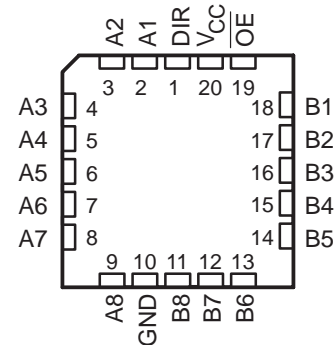


## description

The 'BCT640 bus transceiver is designed for asynchronous communication between data buses. These devices transmit data from the A bus to the B bus or from the B bus to the A bus depending upon the level at the direction-control (DIR) input. The output-enable ( $\overline{OE}$ ) input can be used to disable the device so that the buses are effectively isolated.

The SN54BCT640 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74BCT640 is characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

SN54BCT640 . . . FK PACKAGE  
(TOP VIEW)



FUNCTION TABLE

| INPUTS          |     | OPERATION                    |
|-----------------|-----|------------------------------|
| $\overline{OE}$ | DIR |                              |
| L               | L   | $\overline{B}$ data to A bus |
| L               | H   | $\overline{A}$ data to B bus |
| H               | X   | Isolation                    |



# SN54BCT640, SN74BCT640 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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## recommended operating conditions

|          |                                | SN54BCT640 |     |     | SN74BCT640 |     |     | UNIT |
|----------|--------------------------------|------------|-----|-----|------------|-----|-----|------|
|          |                                | MIN        | NOM | MAX | MIN        | NOM | MAX |      |
| $V_{CC}$ | Supply voltage                 | 4.5        | 5   | 5.5 | 4.5        | 5   | 5.5 | V    |
| $V_{IH}$ | High-level input voltage       | 2          |     |     | 2          |     |     | V    |
| $V_{IL}$ | Low-level input voltage        |            |     | 0.8 |            |     | 0.8 | V    |
| $I_{IK}$ | Input clamp current            |            |     | -18 |            |     | -18 | mA   |
| $I_{OH}$ | High-level output current      | A port     |     | -3  |            |     | -3  | mA   |
|          |                                | B port     |     | -12 |            |     | -15 |      |
| $I_{OL}$ | Low-level output current       | A port     |     | 20  |            |     | 24  | mA   |
|          |                                | B port     |     | 48  |            |     | 64  |      |
| $T_A$    | Operating free-air temperature | -55        |     | 125 | 0          |     | 70  | °C   |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |                | TEST CONDITIONS           |                          | SN54BCT640 |      | SN74BCT640 |      | UNIT  |      |     |
|-----------|----------------|---------------------------|--------------------------|------------|------|------------|------|-------|------|-----|
|           |                |                           |                          | MIN        | TYP† | MAX        | MIN  |       | TYP† | MAX |
| $V_{IK}$  |                | $V_{CC} = 4.5\text{ V}$ , | $I_I = -18\text{ mA}$    |            |      | -1.2       |      | -1.2  | V    |     |
| $V_{OH}$  | A port         | $V_{CC} = 4.5\text{ V}$   | $I_{OH} = -1\text{ mA}$  | 2.5        | 3.4  | 2.5        | 3.4  | V     |      |     |
|           |                |                           | $I_{OH} = -3\text{ mA}$  | 2.4        | 3.3  | 2.4        | 3.3  |       |      |     |
|           | B port         | $V_{CC} = 4.5\text{ V}$   | $I_{OH} = -3\text{ mA}$  | 2.4        | 3.3  | 2.4        | 3.3  |       |      |     |
|           |                |                           | $I_{OH} = -12\text{ mA}$ | 2          | 3.2  |            |      |       |      |     |
|           |                |                           | $I_{OH} = -15\text{ mA}$ |            |      | 2          | 3.1  |       |      |     |
| $V_{OL}$  | A port         | $V_{CC} = 4.5\text{ V}$   | $I_{OL} = 20\text{ mA}$  |            | 0.3  | 0.5        |      | V     |      |     |
|           |                |                           | $I_{OL} = 24\text{ mA}$  |            |      |            | 0.35 |       | 0.5  |     |
|           | B port         | $V_{CC} = 4.5\text{ V}$   | $I_{OL} = 48\text{ mA}$  |            | 0.38 | 0.55       |      |       |      |     |
|           |                |                           | $I_{OL} = 64\text{ mA}$  |            |      |            | 0.42 |       | 0.55 |     |
| $I_I$     | A or B port    | $V_{CC} = 5.5\text{ V}$ , | $V_I = 5.5\text{ V}$     |            |      | 1          |      | 1     | mA   |     |
|           | Control inputs |                           |                          |            |      | 0.1        |      | 0.1   |      |     |
| $I_{IH}‡$ | A or B port    | $V_{CC} = 5.5\text{ V}$ , | $V_I = 2.7\text{ V}$     |            |      | 70         |      | 70    | µA   |     |
|           | Control inputs |                           |                          |            |      | 20         |      | 20    |      |     |
| $I_{IL}‡$ | A or B port    | $V_{CC} = 5.5\text{ V}$ , | $V_I = 0.5\text{ V}$     |            |      | -0.6       |      | -0.6  | mA   |     |
|           | Control inputs |                           |                          |            |      | -0.65      |      | -0.65 |      |     |
| $I_{OS}§$ | A port         | $V_{CC} = 5.5\text{ V}$ , | $V_O = 0$                |            |      | -60        |      | -150  | mA   |     |
|           | B port         |                           |                          |            |      | -100       |      | -225  |      |     |
| $I_{CCL}$ | A to B         | $V_{CC} = 5.5\text{ V}$   |                          |            | 53   | 84         |      | 53    | 94   | mA  |
| $I_{CCH}$ | A to B         | $V_{CC} = 5.5\text{ V}$   |                          |            | 23   | 37         |      | 23    | 41   | mA  |
| $I_{CCZ}$ |                | $V_{CC} = 5.5\text{ V}$   |                          |            | 4    | 10         |      | 4     | 11   | mA  |

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ For I/O ports, the parameters  $I_{IH}$  and  $I_{IL}$  include the off-state output current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.



# SN54BCT640, SN74BCT640 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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## switching characteristics (see Note 2)

| PARAMETER        | FROM<br>(INPUT)        | TO<br>(OUTPUT) | V <sub>CC</sub> = 5 V,<br>C <sub>L</sub> = 50 pF,<br>R <sub>1</sub> = 500 Ω,<br>R <sub>2</sub> = 500 Ω,<br>T <sub>A</sub> = 25°C |     |     | V <sub>CC</sub> = 4.5 V to 5.5 V,<br>C <sub>L</sub> = 50 pF,<br>R <sub>1</sub> = 500 Ω,<br>R <sub>2</sub> = 500 Ω,<br>T <sub>A</sub> = MIN to MAX† |      |            |      | UNIT |
|------------------|------------------------|----------------|--|-----|-----|--|------|------------|------|------|
|                  |                        |                | 'BCT640  |     |     | SN54BCT640   |      | SN74BCT640 |      |      |
|                  |                        |                | MIN  | TYP | MAX | MIN  | MAX  | MIN        | MAX  |      |
| t <sub>PLH</sub> | A or B                 | B or A         | 0.5  | 3.6 | 5.6 | 0.5  | 7    | 0.5        | 6.5  | ns   |
| t <sub>PHL</sub> |                        |                | 0.5  | 1.9 | 3.4 | 0.5  | 3.8  | 0.5        | 3.7  |      |
| t <sub>PZH</sub> | $\overline{\text{OE}}$ | A or B         | 3.1  | 6.4 | 8.9 | 2.6  | 10.5 | 2.6        | 10.2 | ns   |
| t <sub>PZL</sub> |                        |                | 4.1  | 6.9 | 9.5 | 3.5  | 12.3 | 3.5        | 10.7 |      |
| t <sub>PHZ</sub> | $\overline{\text{OE}}$ | A or B         | 1.9  | 5   | 7.9 | 1.4  | 12.2 | 1.4        | 10.2 | ns   |
| t <sub>PLZ</sub> |                        |                | 1.8  | 4.3 | 6.8 | 1.5  | 8.3  | 1.5        | 7.8  |      |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                  | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|---------------------|--------------------------------------|----------------------|--------------|--|-------------------------|
| 5962-9075201M2A  | ACTIVE        | LCCC         | FK              | 20   | 55          | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-<br>9075201M2A<br>SNJ54BCT<br>640FK | <a href="#">Samples</a> |
| 5962-9075201MRA  | ACTIVE        | CDIP         | J               | 20   | 20          | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9075201MR<br>A<br>SNJ54BCT640J      | <a href="#">Samples</a> |
| 5962-9075201MSA  | ACTIVE        | CFP          | W               | 20   | 25          | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9075201MS<br>A<br>SNJ54BCT640W      | <a href="#">Samples</a> |
| SN74BCT640DW     | ACTIVE        | SOIC         | DW              | 20   | 25          | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | BCT640                                   | <a href="#">Samples</a> |
| SN74BCT640N      | ACTIVE        | PDIP         | N               | 20   | 20          | RoHS &<br>Non-Green | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | SN74BCT640N                              | <a href="#">Samples</a> |
| SN74BCT640NSR    | ACTIVE        | SOP          | NS              | 20   | 2000        | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | BCT640                                   | <a href="#">Samples</a> |
| SNJ54BCT640FK    | ACTIVE        | LCCC         | FK              | 20   | 55          | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-<br>9075201M2A<br>SNJ54BCT<br>640FK | <a href="#">Samples</a> |
| SNJ54BCT640J     | ACTIVE        | CDIP         | J               | 20   | 20          | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9075201MR<br>A<br>SNJ54BCT640J      | <a href="#">Samples</a> |
| SNJ54BCT640W     | ACTIVE        | CFP          | W               | 20   | 25          | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9075201MS<br>A<br>SNJ54BCT640W      | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF SN54BCT640, SN74BCT640 :**

● Catalog : [SN74BCT640](#)

● Military : [SN54BCT640](#)

NOTE: Qualified Version Definitions:

● Catalog - TI's standard catalog product

● Military - QML certified for Military and Defense Applications

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74BCT640NSR | SOP          | NS              | 20   | 2000 | 330.0              | 24.4               | 8.4     | 13.0    | 2.5     | 12.0    | 24.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74BCT640NSR | SOP          | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |



**TUBE**


\*All dimensions are nominal

| Device          | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-9075201M2A | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| 5962-9075201MSA | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |
| SN74BCT640DW    | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74BCT640N     | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SNJ54BCT640FK   | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| SNJ54BCT640W    | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14                     | 16                     | 18                     | 20                     |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A             | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX         | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN         | —                      | —                      | —                      | —                      |
| C MAX         | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN         | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## GENERIC PACKAGE VIEW

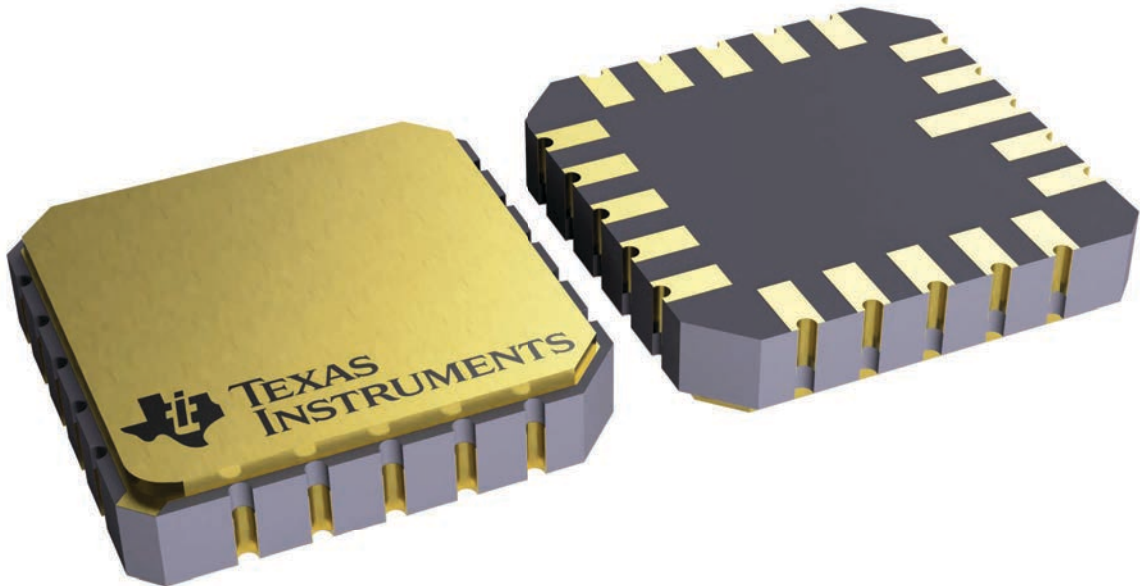
**FK 20**

**LCCC - 2.03 mm max height**

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4229370VA\

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - $\triangle C$  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - $\triangle D$  The 20 pin end lead shoulder width is a vendor option, either half or full width.

# DW0020A



# PACKAGE OUTLINE

## SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

**NOTES:**

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within Mil-Std 1835 GDFP2-F20

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